

Issue	Cover Story	Trend & Analysis				Design & Technology			
		Technology Trends	Opinions	Interview	China Fabless	Design Corner	Test & Measurement	New Products	Hardware Innovation
January Ad Booking Deadline: 23-Nov-2022 Ad Materials Deadline: 28-Nov-2022	Newyear Outlook	•	•	•	•	- Mixed Signal Circuit Design - Data Security and Encryption - MCU	Microwave RF Test	•	
February Ad Booking Deadline: 23-Dec-2022 Ad Materials Deadline: 28-Dec-2022	New Energy/Carbon Neutral	•	•	•	•	- Smart Grid - Wireless Communication - Analog Circuit Design	Oscilloscope	•	•
March Ad Booking Deadline: 19-Jan-2023 Ad Materials Deadline: 20-Jan-2023	EDA tools/full process	•	•	•	•	- LED Lighting - Photoelectric and Display - MEMS Sensor	EMI Test	•	•
April Ad Booking Deadline: 23-Feb-2023 Ad Materials Deadline: 28-Feb-2023	Panel driver/power chip	•	•	•	•	- Motor Control - RF/Microwave - Servo Control	Network Analyzer	•	
May Ad Booking Deadline: 23-Mar-2023 Ad Materials Deadline: 28-Mar-2023	RF/Wireless Communications	•	•	•	•	- Wearable Gadget Design - Energy Acquisition - Digital Signal Processing	Test Software /IP	•	•
June Ad Booking Deadline: 24-Apr-2023 Ad Materials Deadline: 28-Apr-2023	Automotive grade chip/MCU	•	•	•	•	- Medical Electronics - DC/DAC - Edge Computing	Signal Integrity Measurement	•	
July Ad Booking Deadline: 23-May-2023 Ad Materials Deadline: 29-May-2023	Chiplet/3D IC	•	•	•	•	- Audio Design - FPGA/DSP - Wafer Foundry	Impedance Measurement	•	•
August Ad Booking Deadline: 21-Jun-2023 Ad Materials Deadline: 28-Jun-2023	RISC-V	•	•	•	•	- EMI/EMC - Circuit Protection - Radar Technology	Embedded System Test	•	
September Ad Booking Deadline: 24-Jul-2023 Ad Materials Deadline: 28-Jul-2023	Domestic analog IC and IDMs	•	•	•	•	- Human-Machine Interaction - Touch Technology - Speech Recognition / Processing	Mixed Signal Measurement	•	•
October Ad Booking Deadline: 23-Aug-2023 Ad Materials Deadline: 28-Aug-2023	Mobile satellite communication	•	•	•	•	- Power Device - Low Power Design - Digital Power	Vector Signal Analysis	•	
November Ad Booking Deadline: 22-Sep-2023 Ad Materials Deadline: 28-Sep-2023	Machine Vision/AI	•	•	•	•	- 5G Communication - Wireless Connection - Video Surveillance	Spectrum Analyzer	•	•
December Ad Booking Deadline: 23-Oct-2023 Ad Materials Deadline: 27-Oct-2023	"Big chips" for data center	•	•	•	•	- PCB Design - High Frequency Design - Embedded Design	Power Integrity Measurement	•	

* For China edition only

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Note: The publisher retains the right to reschedule any topic in the calendar.